GaN Films under Different Growth Mechanisms Studied by Synchrotron X-ray Absorption Spectroscopy

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Abstract: Synchrotron radiation X-ray absorption measurements were performed to study the structure of Si-doped n-type GaN layers grown on sapphire by metalorganic chemical vapor deposition (MOCVD) and undoped GaN epitaxial layers grown on Si by molecular beam epitaxy (MBE). It was found that the anisotropic characteristic of p-orbital from GaN/sapphire grown by MOCVD is somehow larger than GaN/Si grown by MBE. In addition, values of the lattice constant of different GaN films were deduced from the interatomic distances in the second coordination shell around Ga by extended X-ray absorption fine structure (EXAFS) analysis and the residual strain of the films was then deduced. The calculation results shows that the strain type is different in the two sets of samples which is due to the different substrate and AlN buffer layer.

Introduction

In recent years, GaN and related materials have enabled many applications such as light emitting diodes (LED), blue/UV semiconductor lasers, high power electronic devices and solar cells[1,2]. Since GaN is an excellent piezoelectric material, a small stress can offer a significant contribution to their physical properties and the performance of GaN based optoelectronic devices [3,4]. However, most GaN is grown on sapphire, silicon or SiC substrates, which usually results in large biaxial stress in the epitaxial layers due to the different thermal expansion coefficients and lattice constants between these layers and the substrate. The stress is compressive for GaN grown on sapphire, while the stress is opposite for GaN deposited on 6H-SiC and Si[5]. Such a residual stress inevitably exists in most GaN hetero-epitaxial layers and could limit the applications of GaN in optoelectronic devices. Si-doping is normally used to form n-type GaN and highly Si doped GaN is expected to form low resistance n-type conductive layers in nitride-based LEDs, laser, and optoelectronic devices[6]. It has been reported [7] that a generation of misfit dislocations occurs at GaN-hetero-structure and stress is relaxed through the Si-doping in GaN. It is also found that incorporation of silicon in GaN can improve the layer quality with a small stress [8]. Strain engineering seems a key for growth of high quality GaN on non-native substrates.

Synchrotron radiation (SR) technology is an advanced and powerful tool to characterize wide gap...
semiconductor materials and to allow investigation into atomic level. We have in recent years employed SR X-ray absorption spectroscopy (XAS) to investigate different materials, such as SiC, CdZnTe, MgZnO, AlGaN, etc. [9-12]. In this paper, we perform a SR extended X-ray absorption fine structure (EXAFS) investigation for GaN thin films grown on sapphire and on Si. The bond length around the Ga atom and the strain of the GaN films can be obtained and to compare with Raman measurements.

Experiments

Four samples labeled as P1, P2, S1 and S2 respectively are involved in this study. P1 and P2 are two Si-doped n-type GaN films grown on c-sapphire at 1038°C with the GaN buffer grown at about 530°C by MOCVD[13]. The other two un-doped GaN films were grown on (111) Si substrate with the AlN buffer by MBE [14]. Growth temperature for AlN buffer was between 650°C and 800°C and the typical AlN buffer layer thickness was about 10 nm [14]. X-ray absorption fine-structure spectra were measured for the GaN samples at Ga K-edges in X-ray fluorescence yield mode at beamline 17C of the Synchrotron Radiation Research Center in Hsinchu, Taiwan. Polarization EXAFS were operated at 15° and 90°, which are the angles between the sample surface normal direction and the X-ray incident direction.

Results and Discussion

The Ga K-edge near edge X-ray absorption fine structure (NEXAFS) spectra under different X-ray incident angles of the samples P1, P2, S1, S2 are shown in Fig.1. The variation of the NEXAFS peaks under grazing incidence can be seen more clearly than that under normal incidence. This is because the information depth under the grazing incidence is smaller than the depth under the normal incidence. The spectrum with the normal incidence has more contributions from the crystalline GaN. On the contrary, the spectrum under the grazing incidence has more contributions from the amorphous GaN on the surface which will cause the difference of the NEXAFS peaks between the doped and undoped samples. Comparison of NEXAFS spectra recorded at two incident angles 90° and 15° is made for the MOCVD GaN/sapphire P2 at inset (1) and for MBE GaN/Si S2 at inset (2), respectively. It is seen that the anisotropic characteristic of p-orbital from GaN/sapphire by MOCVD is slightly larger than GaN/Si by MBE. A low anisotropic in wurtzite GaN might indicate more portion of polycrystalline hexagonal with random orientation or the inclusions of cubic phase.

![Fig.1 Ga K-edge NEXAFS spectra under (a) grazing incidence and (b) normal incidence](image)

Polarization dependent EXAFS were performed for four samples at the Ga K-edge. In the wurtzite structure of GaN, the four N atoms in the first shell around the absorbing Ga atom are not at the same distance: here is a longer bond along the c-axis while the three shorter bonds are slightly inclined with
respect to the c-plane. This leads to the first shell XAFS having a different signal in the grazing and normal incidence of X-ray. However, the splitting in the first shell is very small, about 0.007 Å, and the Ga-N first shell was fitted with a single contribution. The Ga-Ga second shell is, in contrast, strongly influenced by the polarization geometry, and indeed it is the value of the second shell distances that provide us with information on the strain in the GaN epilayer since they have a simple relation to the in-plane and out-of-plane lattice parameters, \( a \) and \( c \). In bulk GaN, six Ga atoms lie in the same (0001) basal plane as the central atom at a distance

\[
R_{\text{Ga-Ga}}^{\text{in}} = a. (1)
\]

And the other six Ga atoms, positioned in parallel basal planes (three atoms above and three below), are at a distance

\[
R_{\text{Ga-Ga}}^{\text{out}} = \sqrt{\frac{1}{2}a^2 + \frac{1}{4}c^2}. \quad (2)
\]

Under the grazing incidence of the X-ray, only the six Ga atoms above and below the basal plane contribute to the spectrum and the measured distance can be given by Eq. (2). The sample P1 EXAFS data fitting was performed in Fig. 2 as an example using the IFEFFIT program by three steps[15]: (i) the XAFS data under grazing incidence of X-ray is fitted to obtain the value of \( R_{\text{Ga-Ga}}^{\text{out}} \) for out-of-plane atoms as shown in Fig. 2(a); (ii) the fit of the XAFS data under normal incidence of X-ray is performed considering a split Ga-Ga second shell. The interatomic distance of one of the two subshells is fixed to \( R_{\text{Ga-Ga}}^{\text{out}} \) and the other’s is to obtain the in-plane Ga-Ga interatomic distance \( R_{\text{Ga-Ga}}^{\text{in}} \), as shown in Fig. 2(b); (iii) the value of lattice constant \( a \) equals to the in-plane Ga-Ga interatomic distance \( R_{\text{Ga-Ga}}^{\text{in}} \) and \( c \) can be obtained by considering the given relation between \( c \) and \( R_{\text{Ga-Ga}}^{\text{out}} \). The fitting results are reported in Table 1.

![Fig.2 Fourier transformed EXAFS spectra around Ga K edge of sample P1. (a) Under grazing incidence. (b) Under normal incidence.](image)

Fig. 2 Fourier transformed EXAFS spectra around Ga K edge of sample P1. (a) Under grazing incidence. (b) Under normal incidence.

The lattice constants \( a \) and \( c \) can be obtained from the interatomic distances in the second coordination shell around Ga by using Eq. (1), (2) and the calculation results are listed in Table 2. The lattice constants \( a_0 \) of 3.1878 Å and \( c_0 \) of 5.1850 Å from relaxed, and unstrained bulk GaN were also listed in Table 2 [16]. It’s observed that the lattice constants of GaN grown on sapphire (P1 and P2) are smaller than the unstrained bulk GaN’s which means a compressive stress existing in the epitaxial films. However considering the samples S1 and S2 grown on silicon by MBE, the lattice constants of S1 are smaller than the unstrained bulk GaN’s and the lattice constants of S2 are larger than the
unstrained bulk GaN’s. So, the strain is compressive in S1 and tensile in S2. The strain values can be quantitatively calculated by the following equations:

\[ \varepsilon_x = a/a_0 - 1, (3) \]

and

\[ \varepsilon_z = c/c_0 - 1, (4) \]

The calculation results are listed in Table 2. For a convenient comparison, the values of strain deduced from Raman line shape analysis are also listed in Table 2. It is observed that the \( \varepsilon_x \) values obtained from two techniques have the same sign and are of the same order of magnitude for all the experimental samples. Moreover, the \( \varepsilon_x \) value of the same sample deduced from Raman analysis (which to be reported elsewhere) is close to the value deduced from EXAFS analysis, especially for the samples P1 and S1. It indicates that polarization EXAFS can be a useful method for calculation strain. The \( \varepsilon_x \) sign of S1 is different with the \( \varepsilon_x \) sign of S2, which indicates the stress type in the two samples is different each other. It is due to the AlN interlayer and the different growing conditions. A systematic work will be carried out to investigate the effect of AlN interlayer on stress.

Table 1 Results of the quantitative XAFS analysis

<table>
<thead>
<tr>
<th>Sample</th>
<th>( R_{GaN} (\text{Å}) )</th>
<th>( \sigma_{GaN}^2 (\text{Å}^2) )</th>
<th>( R_{GaGa}^{out} (\text{Å}) )</th>
<th>( R_{GaGa}^{in} (\text{Å}) )</th>
<th>( \sigma_{GaGa}^2 (\text{Å}^2) )</th>
</tr>
</thead>
<tbody>
<tr>
<td>P1</td>
<td>1.9306</td>
<td>0.0013</td>
<td>3.1713</td>
<td>3.1825</td>
<td>0.0044</td>
</tr>
<tr>
<td>P2</td>
<td>1.9329</td>
<td>0.0013</td>
<td>3.1716</td>
<td>3.1767</td>
<td>0.0044</td>
</tr>
<tr>
<td>S1</td>
<td>1.9452</td>
<td>0.0037</td>
<td>3.1765</td>
<td>3.1834</td>
<td>0.0054</td>
</tr>
<tr>
<td>S2</td>
<td>1.9520</td>
<td>0.0036</td>
<td>3.1833</td>
<td>3.1902</td>
<td>0.0045</td>
</tr>
</tbody>
</table>

Table 2 Lattice constants and strain obtained from EXAFS and strain from Raman analysis

<table>
<thead>
<tr>
<th></th>
<th><em>bulk</em></th>
<th>P1</th>
<th>P2</th>
<th>S1</th>
<th>S2</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>( a (\text{Å}) )</strong></td>
<td>3.1878</td>
<td>3.1825</td>
<td>3.1767</td>
<td>3.1834</td>
<td>3.1902</td>
</tr>
<tr>
<td><strong>( c (\text{Å}) )</strong></td>
<td>5.1850</td>
<td>5.1695</td>
<td>5.1750</td>
<td>5.1816</td>
<td>5.1926</td>
</tr>
<tr>
<td>( \varepsilon_z \left(\times 10^{-3}\right) )</td>
<td>EXAFS</td>
<td>-2.99</td>
<td>-1.93</td>
<td>-0.66</td>
<td>1.47</td>
</tr>
<tr>
<td>( \varepsilon_x \left(\times 10^{-3}\right) )</td>
<td>EXAFS</td>
<td>-1.67</td>
<td>-3.48</td>
<td>-1.38</td>
<td>0.75</td>
</tr>
<tr>
<td>( \varepsilon_x \left(10^{-3}\right) )</td>
<td>Raman</td>
<td>-1.23</td>
<td>-2.19</td>
<td>-1.43</td>
<td>0.48</td>
</tr>
</tbody>
</table>

Summary

SRX-ray absorption spectroscopy was utilized to study two sets of GaN epitaxial films grown on different substrates by different technology. Polarization-dependent near edge X-ray absorption fine structure analysis shows that GaN/sapphire grown by MOCVD has a larger anisotropic character comparing with GaN/Si grown by MBE. By theoretical fitting the extended X-ray absorption fine structure, the bond length of Ga-N and Ga-Ga were obtained and then values of the lattice constants and strains from different GaN films were calculated. The calculation results shows that a compressive strain exists in P1, P2 and S1. A tensile strain exists in S2. These results correspond well with the calculation results deduced from Raman scattering analysis. SR X-ray absorption spectroscopy not only can be utilized to study the structure of GaN, but also can be used to investigate the strains.

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References


